		Course Code and Title	
	SCHOOL OF ELECTRICAL, ELECTRONICS, AND	ECEA1 MICROELEC	-
	COMPUTER ENGINEERING	Curriculum:	
		2020-2023	Page 1 of 9
Prepared by:	Approved by:	Revision Date:	Effectivity Date:
FEBUS REIDJ G. CRUZ	floraliente FLORDELIZA L. VALIENTE	Aug 2023	1Q 2023-2024

VISION

Mapua University, a global leader in education, fosters sustainable socio-economic growth through innovation, digital transformation, and lifelong education.

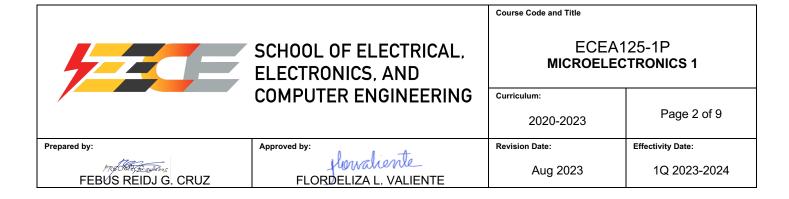
MISSION

- 1. The University shall provide a learning environment in order for its students to acquire the attributes that will make them globally competitive.
- 2. The University shall engage in publishable and/or economically viable research, development and innovation.
- 3. The University shall provide state-of-the-art solutions to problems of industries and communities.

	PROGRAM EDUCATIONAL OBJECTIVES		MISSION			
Withir	n five years after graduation, graduates of the Electronics Engineering program should have:	1	2	3		
1.	Undertaken, singly or in teams, projects that show ability to solve complex engineering problems.	✓	✓	✓		
2.	Had substantial involvement in projects that take into consideration safety, health, environmental concerns and the public welfare, partly through adherence to required codes and laws.	✓	✓	✓		
3.	Demonstrated professional success via promotions and/or positions of increasing responsibility.	✓				
4.	Demonstrated life-long learning via progress toward completion of an advanced degree, professional development/continuing education courses, or industrial training courses.	✓	✓	✓		
5.	Demonstrated technical expertise, professionalism, and ethics in ICT, entrepreneurship or other related fields in the practice of Electronics Engineering for the advancement of industry and society.	✓		✓		

	ABET Student Outcomes	Program Educational Objectives						
		1	2	3	4	5		
1	An ability to identify, formulate, and solve complex engineering problems by applying principles of engineering, science, and mathematics	✓			✓	✓		
2	An ability to apply engineering design to produce solutions that meet specified needs with consideration of public health, safety, and welfare, as well as global, cultural, social, environmental, and economic factors	✓	✓		✓	✓		
3	An ability to communicate effectively with a range of audiences	✓	✓			✓		
4	An ability to recognize ethical and professional responsibilities in engineering situations and make informed judgments, which must consider the impact of engineering solutions in global, economic, environmental, and societal contexts		✓	✓	✓	✓		
5	An ability to function effectively on a team whose members together provide leadership, create a collaborative and inclusive environment, establish goals, plan tasks, and meet objectives	✓	✓	✓	✓	✓		
6	An ability to develop and conduct appropriate experimentation, analyze and interpret data, and use engineering judgment to draw conclusions	✓	✓		✓	✓		
7	An ability to acquire and apply new knowledge as needed, using appropriate learning strategies.	✓	✓	✓	✓	✓		

	PTC and CHED Student Outcomes	ı	Prograi Ol	m Edu bjectiv		al
		1	2	3	4	5
Α	An ability to apply knowledge of mathematics and science to solve complex engineering problems	✓			✓	✓
В	An ability to design and conduct experiments, as well as to analyze and interpret from data	✓	✓		✓	✓
С	An ability to design a system, component, or process to meet desired needs within realistic constraints such					
	as economic, environmental, social, political, ethical, health and safety, manufacturability, and sustainability, in accordance with standards	✓	✓		✓	✓
D	An ability to function on multidisciplinary teams	✓	✓	✓	✓	
Ε	An ability to identify, formulate, and solve engineering problems	✓			✓	✓
F	An understanding of professional and ethical responsibility		✓	✓	✓	✓
G	An ability to communicate effectively	✓	✓			✓
Н	The broad education necessary to understand the impact of engineering solutions in the global and societal context		✓		✓	✓
1	A recognition of the need for, and an ability to engage in life-long learning				✓	✓
J	A knowledge of contemporary issues	✓	✓		✓	✓
K	An ability to use the techniques, skills, and modern engineering tools necessary for engineering practice	✓		✓		✓
L	Knowledge and understanding of engineering and management principles as a member and leader in a team, to manage projects in multidisciplinary environments	✓	✓	✓		✓
M	Understand at least one specialized field of Electronics Engineering practice		✓		✓	✓



COURSE SYLLABUS

1. Course Code: ECEA125-1P

2. Course Title: MICROELECTRONICS 1

3. Pre-requisite: 3rd year standing

4. Co-requisite: none

5. Credit: 3 units / 3 lecture hours and 4.5 laboratory hours per week

6. Course Description: An introductory course in microelectronics specialization. Comprised of three modules, namely: ECEA125-1PM1 - Microelectronics Overview, Technology, and Fabrication; ECEA125-1PM2 - Integrated Circuit Layer, Device, and Layout; and ECEA125-1PM3: Integrated Circuit Netlist, Model, and Simulation.

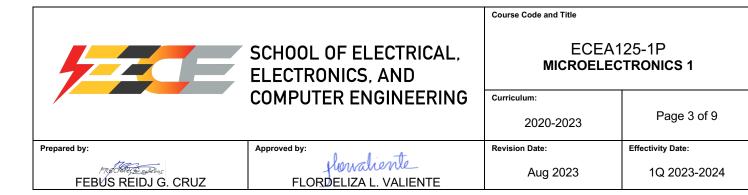
7. Course Outcomes (COs) and Relationship to General Education Outcomes

After completing the course, the students must be able to:	St	Student Outcomes* ABET						Student Outcomes* PTC and CHED										
After completing the course, the students must be able to.	1	2	3	4	5	6	7	Α	В	С	D	Е	F	G	ΗΙ	J	K	LN
Module 1: Microelectronics Overview, Technology, and	Fab	ric	ati	on														
Explain the scope of microelectronics and illustrate the process flow of integrated circuit fabrication.	R					R		R	R	R							R	F
Module 2: Integrated Circuit Layer, Device, and Layout			•			•							•					
2. Make use of design rules and apply the properties of layers to draw the layout of integrated circuit.	R					R		R	R	R							R	R
Module 3: Integrated Circuit Netlist, Model, and Simula	tion																	
3. Utilize the device models in circuit simulation tool to develop and to characterize a sample integrated circuit.	R					R		R	R	R							R	R

Level: I – Introduced; R – Reinforced; D – Demonstrated

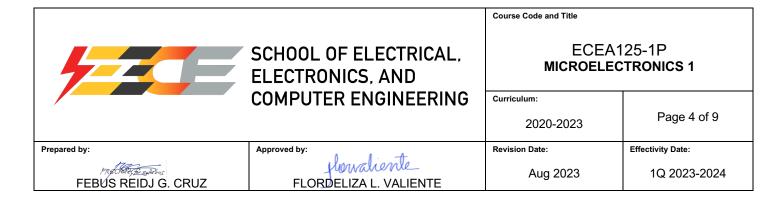
8. Outcome-Based Modular Course Design

Course Title	Credit Units	Module Code	Module Title	Lec Hrs.	Lab Hrs.	Weeks	Credit Units	Pre- requisites	May be taken if remedial
		ECEA125-1PM1	Microelectronics Overview, Technology, and Fabrication	12	18	4	1		Yes
Microelectronics 1	3	ECEA125-1PM2	Integrated Circuit Layer, Device, and Layout	12	18	4	1		Yes
		ECEA125-1PM3	Integrated Circuit Netlist, Model, and Simulation	9	13.5	3	1		Yes

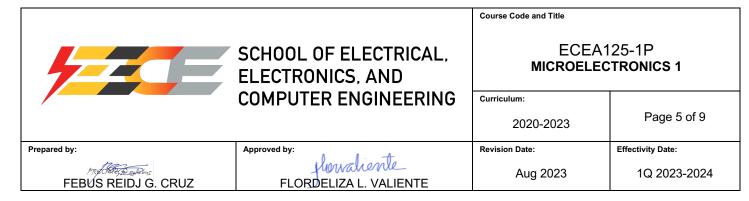


9. Course Coverage

ek	T !.	ession		TLA			AT		La construe Objects	
Week	Topic	Ses	F2F (Onsite)	Synchronous Online	Asynchronous Online	F2F (Onsite)	Synchronous Online	Asynchronous Online	Learning Objects	СО
Mo	odule 1: Microelectronics Overvie	ew, T	echnology, and	Fabrication						
	Course Orientation Microelectronics Overview	1	1	Lecture Discussion	n				-Syllabus -Lecture recording	
1	CMOS Fabrication	2		Access	to eBooks				-Ch.7 CMOS Fabrication in: CMOS Circuit Design, Layout, and Simulation by R. Jacob Baker	
2	CMOS Unit Processes	3	I	Lecture Discussion	n				-Lecture recording -Micro-video lecture	
2	CiviO3 Offit Processes	4			ssessment to eBooks		Course	ework 1	-Students' works -Ch.7 CMOS Fabrication	CO1
3	CMOS Dragged Integration	5	!	Lecture Discussion	n				-Lecture recording -Micro-video lecture	
3	CMOS Process Integration	6			ssessment to eBooks		Course	ework 2	-Students' works -Ch.7 CMOS Fabrication	
	Backend Processes	7	!	Lecture Discussion	n				-Lecture recording	
4	Microelectronics Overview, Technology, and Fabrication	8	Problem-based Learning			Exam 1	-Students' w		-Micro-video lecture -Students' works -Ch.7 CMOS Fabrication	



ē	Tania	ssion		TLA			AT		La amaina a Ohia ata	60
Week	Горіс	Topic F2F Synchronous Asynchronous F2F (Onsite) Online Online (Onsite)			Synchronous Online	Asynchronous Online	Learning Objects	СО		
Мс	dule 2: Integrated Circuit Laye	r, Devi				,				
_	The Mari	9		Lecture Discussion	n				-Lecture recording -Micro-video lecture	
5	The Well	10			ssessment to eBooks		Cours	ework 3	-Students' works -Ch.2 The Well	
6	The Metal Layers	11		Lecture Discussion	n				-Lecture recording -Micro-video lecture	
0	The Metal Layers	12			ssessment to eBooks		Cours	ework 4	-Students' works -Ch.3 The Metal Layers	
7	The Active and Deby Lovers	13	1	Lecture Discussion	า				-Lecture recording -Micro-video lecture	CO2
'	The Active and Poly Layers	14			ssessment to eBooks		Cours	ework 5	-Students' works -Ch.4 Active & Poly Layers	
	Integrated Circuit Layers,	15		Lecture Discussion	n				-Lecture recording -Micro-video lecture	
8	Devices, and Layout	16	Problem-based Learning			Exam 2			-Students' works -Ch.5 Resistors, Capacitors, MOSFETs	



ē	T	sion		TLA			AT		L Objects	00
Week	Topic	Ses	F2F (Onsite)	Synchronous Online	Asynchronous Online	F2F (Onsite)	Synchronous Online	Asynchronous Online	Learning Objects	СО
Mc	dule 3: Integrated Circuit Netlis	t, Mod	del, and Simulati	I, and Simulation						
9	Resistors, Capacitors, MOSFETs	17	I	Lecture Discussion	n				-Lecture recording -Micro-video lecture -Students' works	
9	Resistors, Capacitors, MOSPETS	18			ssessment to eBooks		Course	ework 6	-Ch.5 Resistors, Capacitors, MOSFETs	
		19	1	_ecture Discussion	n				-Lecture recording -Micro-video lecture	
10	MOSFET Operation	20			ssessment to eBooks		Course	ework 7	-Students' works -Ch.6 MOSFET Operation	CO3
11	Integrated Circuit Netlist,	21	ı	_ecture Discussion	n		-Micro-vid		-Lecture recording -Micro-video lecture	
11	Model, and Simulation	22	Problem-based Learning			Exam 3			-Students' works -Ch.5 Rs, Cs, MOSFETs -Ch.6 MOSFET Operation	

Approved by:

ECEA125-1P	
MICROELECTRONICS	1

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10. Lifelong-Learning Opportunities

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Prepared by:

The students will use computer-aided-design tools to draw the layout of integrated circuits; and to run simulations for the analysis and characterization of microelectronics devices and circuits; and eventually, design their own integrated circuits.

11. Contribution of Course to Meeting the Professional Component

Engineering Topics: 100%

12. Prescribed E-Book and Courseware

CMOS Circuit Design, Layout, and Simulation by R. Jacob Baker, 4th Edition, John Wiley and Sons, 2019.

13. Other References and Educational Resources

Microelectronics by Behzad Razavi, 2nd Edition International Student Version, John Wiley & Sons, 2015. Understanding Microelectronics: A Top-Down Approach by Franco Maloberti, John Wiley & Sons, 2012. Solid State Physics: An Introduction by Philip Hofmann, Second Edition, Wiley, 2015. Microelectronic Circuits: Analysis and Design by Rashid, 3rd Edition, Cengage, 2017. Mapua E-Text Infinity Solution (METIS).

14. Course Evaluation

Student performance will be rated based on the following:

Assessment Tasks	Weight	Minimum Average for Satisfactory Performance
Coursework	30%	21%
Module Exam	70%	49%
Total	100%	70%

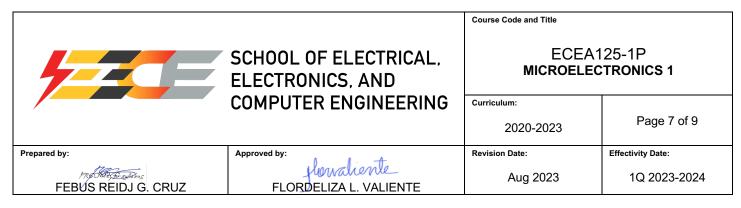
The module grades will correspond to the weighted average scores shown below:

Average	Module Grade	Average	Module Grade
0.00 - 34.99	5.00	83.00 - 85.99	2.00
35.00 – 69.99	IP	86.00 - 89.99	1.75
70.00 - 72.99	3.00	90.00 - 92.99	1.50
73.00 - 75.99	2.75	93.00 - 95.99	1.25
76.00 - 79.99	2.50	96.00 - 100.00	1.00
80.00 - 82.99	2.25	For approved medical reasons only	I

The module grade average will be the weighted average of the module grades based on the credit units of each module:

Module Grade Average
$$\frac{\sum_{i=1}^{\text{no of modules}} \left(\text{credit unit}\right)_i \left(\text{module grade}\right)_i}{\text{total credit units of the course}}$$

The course grade will be determined from the module grade average using the table below:



Module Grade Average (MGA)	Course Grade	
1.00 ≤ MGA ≤ 1.10	1.00	
1.10 < MGA ≤ 1.40	1.25	
1.40 < MGA ≤ 1.60	1.50	
1.60 < MGA ≤ 1.85	1.75	
1.85 < MGA ≤ 2.10	2.00	
2.10 < MGA ≤ 2.40	2.25	
2.40 < MGA ≤ 2.60	2.50	
2.60 < MGA ≤ 2.85	2.75	
2.85 < MGA ≤ 3.00	3.00	
IP	IP	
5.00	5.00	

15. Other Course Policies

a. Attendance

According to CHED policy, a student's total number of absences should not be more than 20% of the total number of meetings or 9 hours for a three-unit course. Students incurring more than 9 hours of unexcused absences automatically get a failing grade regardless of class standing.

b. Guided Learning Output

Guided learning outputs through various worksheets in each cluster of topics are assigned to the students. Problems encountered in the worksheets will be discussed in class.

c. Written Examination

Exams will be given face-to-face for Tri-X, Bio-X, and Blended modes and online for UOX.

d. Course Portfolio

Selected guided learning outputs and examinations are to be compiled and collected before the end of the term. The selection is based on statistical data gathering (lowest, median, highest). Guided learning outputs and examinations with marks lowest, median, and highest must be photocopied and must be given back to the instructor for course portfolio keeping.

e. Language of Instruction

Lectures, discussion, and documentation will be in English. Written and spoken work may receive a lower mark if it is, in the opinion of the instructor, deficient in English.

f. Dress and Grooming Codes

All of us have been instructed on the Dress and Grooming Codes of the University.

g. Academic Integrity Policy

It is the student's responsibility to refrain from infractions of academic integrity, from conduct that may lead to suspicion of such infractions, and from conduct that aids others in such infractions. Any of the following sanctions may be imposed on any student who is found guilty of committing online academic dishonesty:

- a. Failed mark in the course.
- b. Suspension for a period of less than one term, with or without community service.
- c. Suspension for a period of one term or more, with or without community service.
- d. Non-readmission to the University.
- e. Dismissal from the University.
- f. Expulsion.

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FREDUS REIDJ G. CRUZ	floraliente FLORDELIZA L. VALIENTE	Aug 2023	1Q 2023-2024

The following are considered academic dishonesty:

- 1. Using another MyMapua email address to log in to any platform (such as BlackBoard and Coursera) with or without permission.
- 2. Asking or hiring someone else to do their exams, homework, Coursera course, papers, projects, or other academic requirements.
- 3. Recording and saving copies of exam questions or answers, or answer keys for distribution.
- 4. Receiving copies of exam questions or answers, or answer keys to an exam from someone who has already taken it.
- 5. Plagiarizing or the unethical act of stealing the thoughts of another without proper citation or reference, acquiring information from the Internet without acknowledging the author, copying from another student's work without permission, and submitting it as own work.
- 6. Massive, pre-meditated, organized online cheating using instant messaging/email during a quiz or exam.
- 7. Any form of dishonesty in peer-reviewed assignments/submissions (e.g., Coursera peer-graded submissions).
- 8. Engaging in any activities that will dishonestly improve results, or dishonestly improve or damage the results of others.
- 9. Any other form of dishonesty or cheating in any assessment or course requirement.

All students who violate the Academic Integrity Policy of the university will be given zero marks for the exam or for the activity and will be given a failing grade for the course. He or she will also be referred to the Prefect of Discipline for appropriate sanction.

h. Consultation Schedule

Consultation schedules with the Professor are posted outside the EECE Faculty room and in the School web page (http://eece.mapua.edu.ph). It is recommended that the student first set an appointment to confirm the instructor's availability.

i. Appeal System

All appeals on student assessment must be made by the concerned student within one week after the return of the assessed student work.

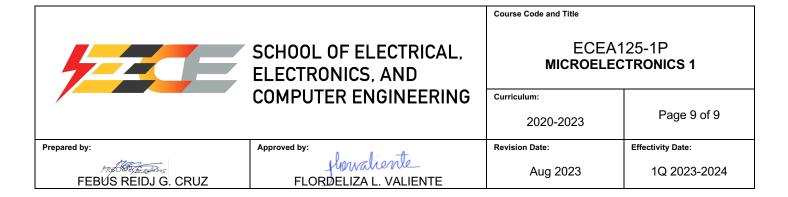
In case the student is not satisfied, no later than one week after the decision of the faculty has been made, he can elevate the appeal to the program chair or dean in case there is no program chair. The decision of the program chair or dean is final. The faculty must abide with the moderated decision of the program chair or dean.

j. Use of Generative Al

It is expected that students will adhere to generally accepted standards of academic honesty, including but not limited to refraining from cheating, plagiarizing, misrepresenting one's work, and/or inappropriately collaborating. This includes the use of generative AI tools that have not been cited or documented or authorized. Students will also be expected to adhere to the prescribed professional and ethical standards of the profession/discipline for which the student is preparing. Any student who engages in academic dishonesty or who violates the professional and ethical standards for the profession/discipline for which the students is preparing, may be subject to academic sanctions as the University's academic Integrity Policy.

16. Course Materials to be Provided to Students

- 16.1. Syllabus
- 16.2. Lecture recording



17. Committee Members

Febus Reidj G. Cruz Ramon G. Garcia Joseph Bryan G. Ibarra Mary Ann E. Latina Charmaine C. Paglinawan Flordeliza L. Valiente Leonardo L. Valiente Jr.